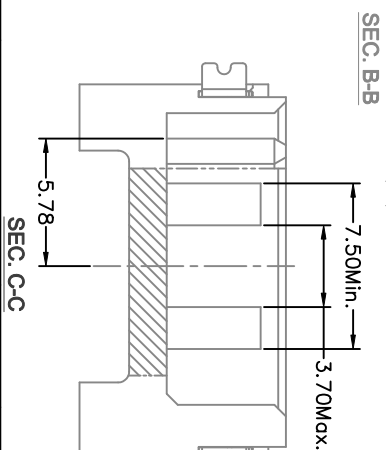


4

1 | 2

3 |

4

NOTES :

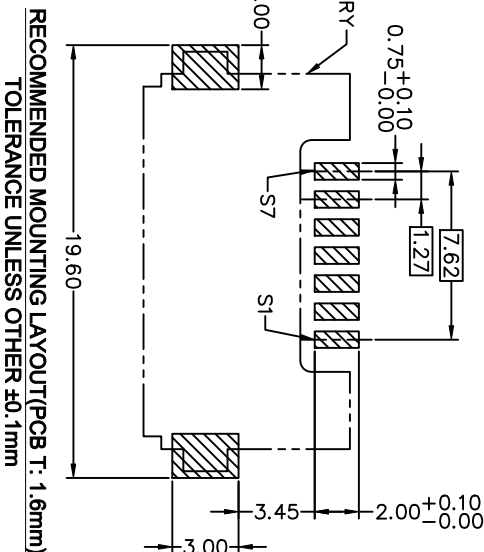
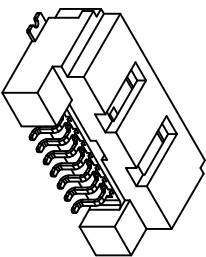
1. MATERIAL
 - i) HOUSING : HIGH TEMPERATURE THERMOPLASTIC UL94V-0
 - ii) TERMINAL : COPPER ALLOY
 - iii) HOLD DOWN : COPPER ALLOY
2. FINISH
 - i) TERMINAL : Au PLATING AT CONTACT POINT
 - ii) MATT TIN PLATING 100u" MIN AT SOLDER TAIL WITH NICKEL 50u" MIN UNDERPLATE.
 - iii) HOLD DOWN : MATT TIN PLATING.
3. THE HOUSING WILL WITHSTAND EXPOSURE TO 260 DEGREE C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFREA RED, OR VAPOR PHASE REFLOW OVEN.
4. Packaging spec. GS-14-840.
5. Product Spec. GS-12-194.

10096851- 0 X X X X LEAD FREE

PRODUCT SPEC: BLANK - SEE NOTE 5

- 1: G/F PLATING AT CONTACT
- 2: 15U" GOLD AT CONTACT
- 3: 30U" GOLD AT CONTACT

0: T & R PACKING WITHOUT PICK UP CAP



mat'l code		tolerances unless otherwise specified		CUSTOMER COPY		title	
ltr	ecn no	dr	ddte	linear	projection	product family	code
A	109-1051	S.LIN	04/10/09	.XXX ± 0.10	MM	S-ATA SIGNAL PLUG SMT RA TYPE ASSY	TWN
				0° ±2°		size	dwg no
				STERLING LIN	04/10/09	SATA	10096851
				engr	04/10/09		2 of
				chr	04/10/09		
				appr	04/10/09		
sheet	revision	A	A				
index	sheet	1	2				

1 | 2

3 |

4